# 506372614 11/25/2020

# PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
DABIN LEE	07/16/2019
MIKYUNG KIM	07/16/2019
HONGHAE DO	07/16/2019
WEONYOUNG SHO	07/16/2019
SUNGMO IM	07/16/2019

#### RECEIVING PARTY DATA

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## **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	17103654

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NAME OF SUBMITTER:	JUSTIN D. LEE
SIGNATURE:	/Justin D. Lee/
DATE SIGNED:	11/24/2020
	-

**Total Attachments: 1** 

PATENT 506372614 REEL: 054467 FRAME: 0155

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PATENT REEL: 054467 FRAME: 0156

### **ASSIGNMENT**

		7,00,0,1	
(1-8)	Insert Name(s) of	(1) Dabin LEE	(5) Sungmo IM
	Inventor(s)	(2) Mikyung KIM	(6)
		(3) Honghae DO	(7)
		(4) Weonyoung SHO	(8)
		valuable consideration	sum of one dollar (\$1.00) and other good and s paid to each of the undersigned, the assign, and hereby does assign, transfer and
(9)	Insert name of Assignee	(9) LG Electronics Inc.	
(10)	Insert state of Incorporation of Assignee	(10) Republic of Korea	
(11)	Insert address of Assignee	(11) 128, Yeoui-daero, Yeon	gdeungpo-gu, Seoul, 07336, Republic of Korea
		(hereinafter designated as the interest in the invention known	e Assignee) the entire worldwide right, title and า as
(12)	Insert identification of Invention, such as Title, Case Number or Foreign Application Number	in the United States of A	ed has (have) executed an application for patent merica and all patent applications in foreign thereto or based thereon.

- 1) The undersigned agree(s) to execute all papers necessary in connection with any original, reissue, divisional and continuing United States and foreign applications for the above-identified invention and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.
- 2) The undersigned agree(s) to execute all papers necessary in connection with any interference which may be declared concerning this application or continuation or division thereof and to cooperate with the Assignee in every way possible in obtaining evidence and going forward with such interference.
- 3) The undersigned agree(s) to execute all papers and documents and perform any act which may be necessary in connection with claims or provisions of the International Convention for Protection of Industrial Property or similar agreements.
- 4) The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent to the Assignee.
- 5) The undersigned hereby authorize(s) and request(s) the Commissioner of Patents to issue any and all Letters Patents of the United States resulting from said application or any division or divisions or continuing applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) full right to convey the entire interest herein assigned, and that he has (they have) not executed any agreement in conflict herewith.

The undersigned hereby appoints **the Attorneys associated with Customer No. 035884** the power to insert on this assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document.

Date:	19. M. 16	Signature of Inventor (1) 01 CHOL 0 CM
Date:	19.1.16	Signature of Inventor (2) 10178 Could
Date:	19.7.16	Signature of Inventor (3) 5334 424
Date:	19,7,16	Signature of Inventor (4)
Date:	19. 1. 16	Signature of Inventor (5) Ob M. J. John

**RECORDED: 11/25/2020**